# BC846/BC546 series

# 65 V, 100 mA NPN general-purpose transistors Rev. 07 — 17 November 2009

**Product data sheet** 

# 1. Product profile

#### 1.1 General description

NPN general-purpose transistors in Surface Mounted Device (SMD) plastic packages.

**Product overview** Table 1.

Type number[1]	Package	PNP		
	NXP	JEITA	JEDEC	complement
BC846	SOT23	-	TO-236AB	BC856
BC846W	SOT323	SC-70	-	BC856W
BC846T	SOT416	SC-75	-	BC856T
BC546A[2]	SOT54	SC-43A	TO-92	BC556A
BC546B[2]	SOT54	SC-43A	TO-92	BC556B

<sup>[1]</sup> Valid for all available selection groups.

#### 1.2 Features

- General-purpose transistors
- SMD plastic packages
- Two different gain selections

#### 1.3 Applications

General-purpose switching and amplification

#### 1.4 Quick reference data

Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CEO}$	collector-emitter voltage	open base	-	-	65	V
I <sub>C</sub>	collector current		-	-	100	mA
h <sub>FE</sub>	DC current gain	$V_{CE} = 5 \text{ V};$ $I_C = 2 \text{ mA}$	110	-	450	
	h <sub>FE</sub> group A		110	180	220	
	h <sub>FE</sub> group B		200	290	450	



<sup>[2]</sup> Also available in SOT54A and SOT54 variant packages (see Section 2).

# 2. Pinning information

Table 3. **Pinning** Pin Description Simplified outline **Symbol** SOT23; SOT323; SOT416 base 3 2 emitter 3 collector 1 2 sym021 006aaa144 SOT54 1 emitter 2 base 3 collector 001aah347 sym026 SOT54A emitter 1 2 base 3 collector 001aab348 sym026 **SOT54** variant 1 emitter 2 base 3 collector 001aab447 sym026

# **Ordering information**

**Ordering information** Table 4.

Type number[1]	Package						
	Name	Description	Version				
BC846	-	plastic surface mounted package; 3 leads	SOT23				
BC846W	SC-70	plastic surface mounted package; 3 leads	SOT323				
BC846T	SC-75	plastic surface mounted package; 3 leads	SOT416				
BC546A[2]	SC-43A	plastic single-ended leaded (through hole) package; 3 leads	SOT54				
BC546B[2]	SC-43A	plastic single-ended leaded (through hole) package; 3 leads	SOT54				

<sup>[1]</sup> Valid for all available selection groups.

# Marking

Table 5. Marking codes

3			
Type number	Marking code <sup>[1]</sup>	Type number	Marking code <sup>[1]</sup>
BC846	1D*	BC846T	1M
BC846A	1A*	BC846AT	1A
BC846B	1B*	BC846BT	1B
BC846W	1D*	BC546A	C546A
BC846AW	1A*	BC546B	C546B
BC846BW	1B*	-	-

<sup>[1] \* = -:</sup> made in Hong Kong

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<sup>[2]</sup> Also available in SOT54 and SOT54 variant packages (see Section 2 and Section 9).

<sup>\* =</sup> p: made in Hong Kong

<sup>\* =</sup> t: made in Malaysia

<sup>\* =</sup> W: made in China

# 5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CBO}$	collector-base voltage	open emitter	-	80	V
$V_{CEO}$	collector-emitter voltage	open base	-	65	V
V <sub>EBO</sub>	emitter-base voltage	open collector	-	6	V
I <sub>C</sub>	collector current		-	100	mA
I <sub>CM</sub>	peak collector current	single pulse; $t_p \le 1 \text{ ms}$	-	200	mA
I <sub>BM</sub>	peak base current	single pulse; $t_p \le 1 \text{ ms}$	-	200	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25  ^{\circ}C$	[1]		
	SOT23		-	250	mW
	SOT323		-	200	mW
	SOT416		-	150	mW
	SOT54		-	500	mW
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-65	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

<sup>[1]</sup> Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

## 6. Thermal characteristics

Table 7. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient	in free air	<u>[1]</u>			
	SOT23		-	-	500	K/W
	SOT323		-	-	625	K/W
	SOT416		-	-	833	K/W
	SOT54		-	-	250	K/W

<sup>[1]</sup> Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

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### **Characteristics**

Table 8. **Characteristics** 

 $T_{amb} = 25$  °C unless otherwise specified.

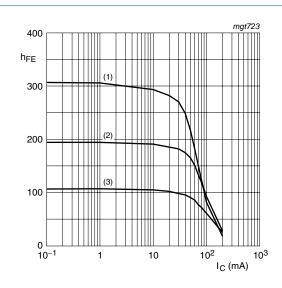
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I <sub>CBO</sub>	collector-base cut-off	$V_{CB} = 30 \text{ V}; I_{E} = 0 \text{ A}$		-	-	15	nA
	current	$V_{CB} = 30 \text{ V; } I_E = 0 \text{ A;}$ $T_j = 150 \text{ °C}$		-	-	5	μΑ
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_{E} = 0 \text{ A}$		-	-	100	nA
h <sub>FE</sub>	DC current gain						
	h <sub>FE</sub> group A	$V_{CE} = 5 \text{ V}; I_{C} = 10 \mu\text{A}$		-	180	-	
	h <sub>FE</sub> group B	$V_{CE} = 5 \text{ V}; I_{C} = 10 \mu\text{A}$		-	290	-	
	DC current gain	$V_{CE} = 5 \text{ V}; I_{C} = 2 \text{ mA}$		110	-	450	
	h <sub>FE</sub> group A	$V_{CE} = 5 \text{ V}; I_{C} = 2 \text{ mA}$		110	180	220	
	h <sub>FE</sub> group B	$V_{CE} = 5 \text{ V}; I_{C} = 2 \text{ mA}$		200	290	450	
$V_{CEsat}$	collector-emitter saturation voltage	$I_C = 10 \text{ mA}; I_B = 0.5 \text{ mA}$		-	90	200	mV
		$I_C = 100 \text{ mA}; I_B = 5 \text{ mA}$	[1]	-	200	400	mV
$V_{BEsat}$	base-emitter	$I_C = 10 \text{ mA}; I_B = 0.5 \text{ mA}$	[2]	-	760	-	mV
	saturation voltage	$I_C = 100 \text{ mA}; I_B = 5 \text{ mA}$	[2]	-	900	-	mV
$V_{BE}$	base-emitter voltage	$I_C = 2 \text{ mA}; V_{CE} = 5 \text{ V}$	[3]	580	660	700	mV
		$I_C = 10 \text{ mA}; V_{CE} = 5 \text{ V}$	[3]	-	-	770	mV
f <sub>T</sub>	transition frequency	$V_{CE} = 5 \text{ V}; I_{C} = 10 \text{ mA};$ f = 100 MHz		100	-	-	MHz
C <sub>c</sub>	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 1 MHz		-	2	3	pF
C <sub>e</sub>	emitter capacitance	$V_{EB} = 0.5 \text{ V}; I_C = i_c = 0 \text{ A};$ f = 1 MHz		-	11	-	pF
NF	noise figure	$I_C = 200 \mu A; V_{CE} = 5 V;$ $R_S = 2 k\Omega; f = 1 kHz;$ B = 200 Hz		-	2	10	dB

<sup>[1]</sup> Pulse test:  $t_p \le 300 \ \mu s; \ \delta \le 0.02$ .

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<sup>[2]</sup>  $V_{BEsat}$  decreases by approximately 1.7 mV/K with increasing temperature.

<sup>[3]</sup> V<sub>BE</sub> decreases by approximately 2 mV/K with increasing temperature.



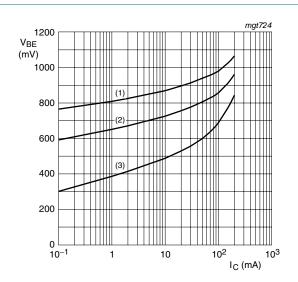
$$V_{CE} = 5 V$$

(1) 
$$T_{amb} = 150 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3) 
$$T_{amb} = -55 \, ^{\circ}C$$

Selection A: DC current gain as a function of Fig 1. collector current; typical values



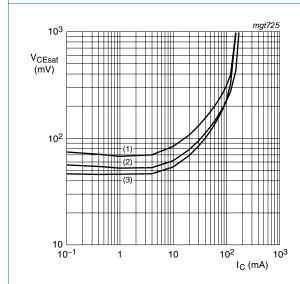
$$V_{CE} = 5 V$$

(1) 
$$T_{amb} = -55 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3) 
$$T_{amb} = 150 \, ^{\circ}C$$

Selection A: Base-emitter voltage as a function Fig 2. of collector current; typical values



$$I_{\rm C}/I_{\rm B} = 20$$

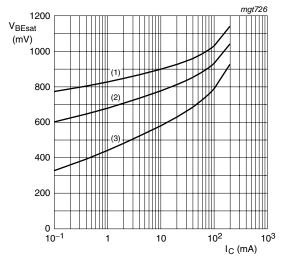
(1) 
$$T_{amb} = 150 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3) 
$$T_{amb} = -55 \, ^{\circ}C$$

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Fig 3. **Selection A: Collector-emitter saturation** voltage as a function of collector current; typical values



$$I_{\rm C}/I_{\rm B} = 10$$

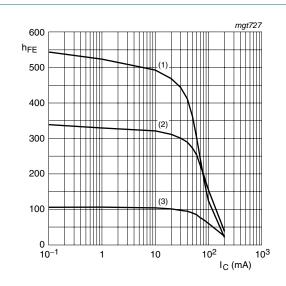
(1) 
$$T_{amb} = -55 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3) 
$$T_{amb} = 150 \, ^{\circ}C$$

Fig 4. Selection A: Base-emitter saturation voltage as a function of collector current; typical values

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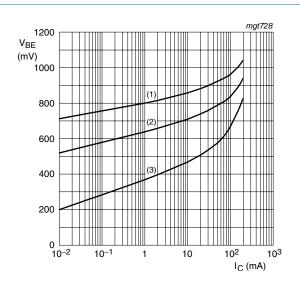
$$V_{CE} = 5 V$$

(1) 
$$T_{amb} = 150 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3) 
$$T_{amb} = -55 \, ^{\circ}C$$

Selection B: DC current gain as a function of Fig 5. collector current; typical values



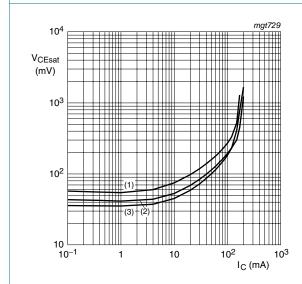
$$V_{CE} = 5 V$$

(1) 
$$T_{amb} = -55 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3) 
$$T_{amb} = 150 \, ^{\circ}C$$

Selection B: Base-emitter voltage as a function Fig 6. of collector current; typical values



$$I_{\rm C}/I_{\rm B} = 20$$

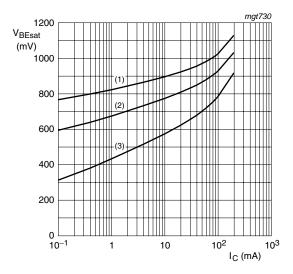
(1) 
$$T_{amb} = 150 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3) 
$$T_{amb} = -55 \, ^{\circ}C$$

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Fig 7. **Selection B: Collector-emitter saturation** voltage as a function of collector current; typical values



$$I_{\rm C}/I_{\rm B} = 10$$

(1) 
$$T_{amb} = -55 \, ^{\circ}C$$

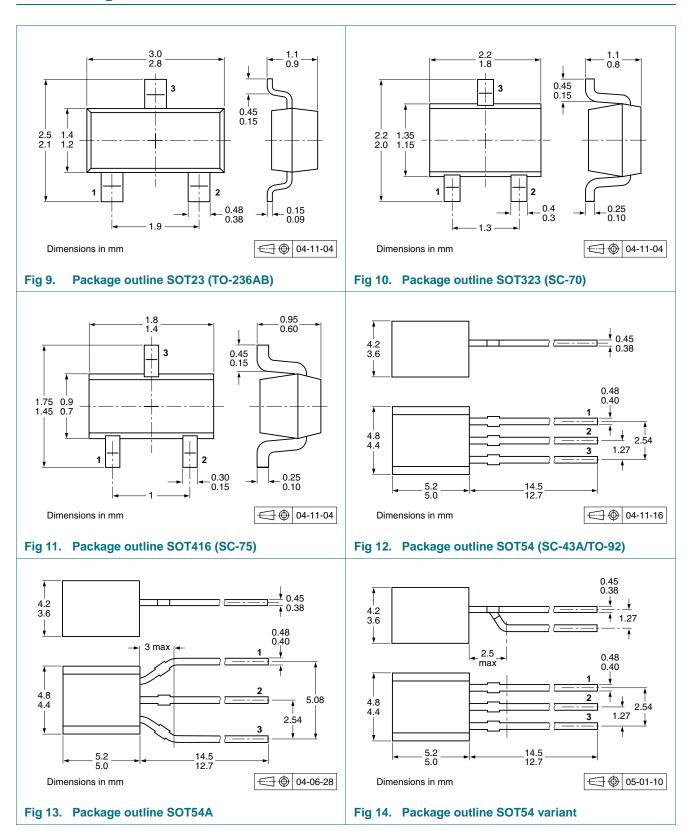
(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3) 
$$T_{amb} = 150 \, ^{\circ}C$$

Fig 8. Selection B: Base-emitter saturation voltage as a function of collector current; typical values

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# 8. Package outline



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# **Packing information**

**Packing methods** Table 9.

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

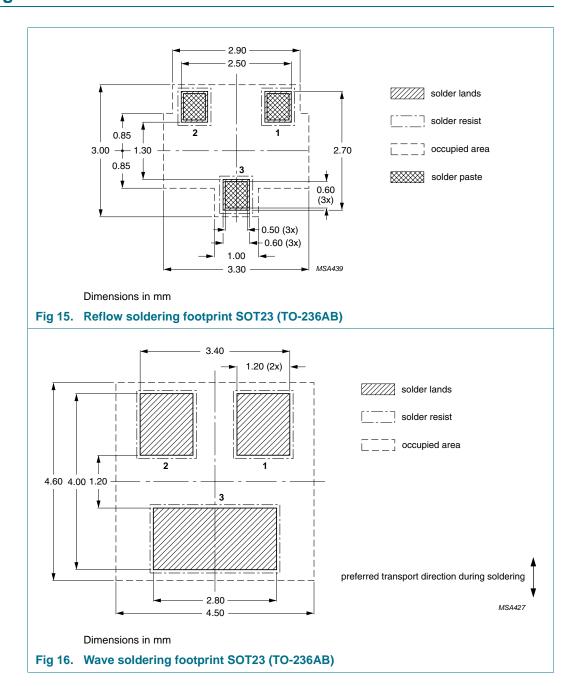
Type number[2]	Package	Description	Packing quantity		
			3000	5000	10000
BC846	SOT23	4 mm pitch, 8 mm tape and reel	-215	-	-235
BC846W	SOT323	4 mm pitch, 8 mm tape and reel	-115	-	-135
BC846T	SOT416	4 mm pitch, 8 mm tape and reel	-115	-	-135
BC546A	SOT54	bulk, straight leads	-	-412	-
	SOT54A	tape and reel, wide pitch	-	-	-116
		tape ammopack, wide pitch	-	-	-126
	SOT54 variant	bulk, delta pinning	-	-112	-
BC546B	SOT54	bulk, straight leads	-	-412	-
	SOT54A	tape and reel, wide pitch	-	-	-116
		tape ammopack, wide pitch	-	-	-126
	SOT54 variant	bulk, delta pinning	-	-112	-

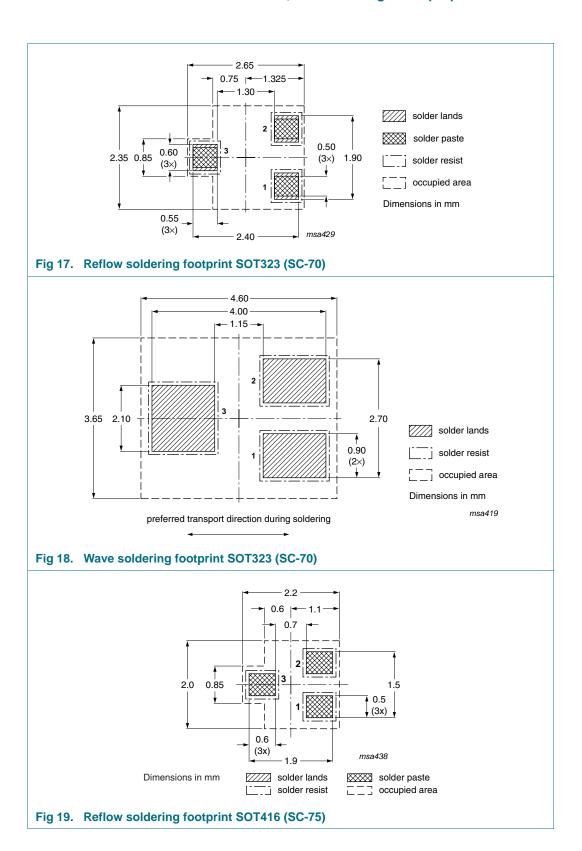
<sup>[1]</sup> For further information and the availability of packing methods, see Section 13.

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<sup>[2]</sup> Valid for all available selection groups.

# 10. Soldering





# 11. Revision history

Table 10. Revision history

	• • •			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BC846_BC546_SER_7	20091117	Product data sheet	-	BC846_BC546_SER_6
Modifications:	including new le content.	was changed to reflect the egal definitions and disclair		
	<ul> <li>Table 3 "Pinning</li> </ul>	<del>_</del>		
	<ul> <li>Figure 17 "Refle</li> </ul>	ow soldering footprint SOT	323 (SC-70)": updated	d
	<ul> <li>Figure 18 "Wave</li> </ul>	e soldering footprint SOT3	23 (SC-70)": updated	
	• Figure 19 "Reflo	ow soldering footprint SOT	416 (SC-75)": updated	d
BC846_BC546_SER_6	20060207	Product data sheet	-	BC846_BC847_ BC848_5 BC846T_847T_ SERIES_3 BC846W_BC847W_ BC848W_4 BC546_547_4
BC846_BC847_BC848_5	20040206	Product specification	-	BC846_BC847_ BC848_4
BC846T_847T_SERIES_ 3	20001115	Product specification	-	BC846T_847T_2
BC846W_BC847W_ BC848W_4	20020204	Product specification	-	BC846W_847W_3
BC546_547_4	20041125	Product specification	-	BC546_547_3

## 12. Legal information

#### 12.1 **Data sheet status**

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- The term 'short data sheet' is explained in section "Definitions" [2]
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# BC846/BC546 series

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